Document Number: STCV38650CY4V Preliminary Datasheet V1.0

Gallium Nitride 50V, 650W, 3.4-3.8GHz RF Power Transistor

Description

The STCV38650CY4V is a 650-watt, internally matched GaN HEMT, designed for 5G cellular applications with frequencies from 3.4-3.8GHz, **enabled by wide band VBW capability to support IBW up to 200MHz.**.

It can be configured as asymmetrical Doherty for 4G or 5G application, delivering 80-100W average power, according to normal 8 to 9dB back off.

There is no guarantee of performance when this part is used in applications designed Outside of these frequencies.

Typical Doherty Pulsed CW and 1C W--CDMA Characterization Performance:

VDD = 50 Vdc, IDQA = 280 mA, VGSB = -6.4Vdc,

1C WCDMA; Signal PAR = 10 dB @ 0.01% Probability on CCDF.

From	Pulse CW Signal ⁽¹⁾				P _{avg} =48.5dBm WCDMA Signal ⁽²⁾			
Freq (GHz)	P1 (dBm)	P1 (W)	P3 (dBm)	P3 (W)	Gp (dB)	η _D (%)	ACPR₅ _M (dBc)	
3.40	56.92	492	58.22	663	10.58	41.42	-33.51	
3.50	58.31	678	58.57	711	11.11	41.02	-34.56	
3.60	57.73	593	58.52	711	11.46	43.32	-34.88	
3.70	56.31	428	58.35	683	11.31	42.43	-37.75	
3.80	58.04	636	58.16	655	11.16	41.49	-31.20	

Applications

- · Asymmetrical Doherty amplifier within N77/78 5G band
- S band power amplifier

Important Note: Proper Biasing Sequence for GaN HEMT Transistors

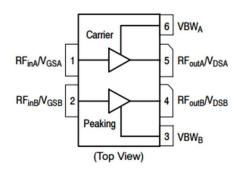
Turning the device ON

- 1. Set VGS to the pinch—off (VP) voltage, typically –5 V
- 2. Turn on VDS to nominal supply voltage
- 3. Increase VGS until IDS current is attained
- 4. Apply RF input power to desired level

Turning the device OFF

- 1. Turn RF power off
- 2. Reduce VGS down to VP, typically -5 V
- 3. Reduce VDS down to 0 V
- 4. Turn off VGS

Figure 1: Pin Connection definition







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Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain—Source Voltage	V _{DSS}	+200	Vdc
Gate—Source Voltage	V _{GS}	-8 to +0.5	Vdc
Operating Voltage	V _{DD}	55	Vdc
Maximum gate current	Igs	85	mA
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	T _C	+150	°C
Operating Junction Temperature	TJ	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case by FEA	Po IC	0.8	°C /W
T _C = 85°C, Pout=80W, 3.8GHz Doherty application board	Rejc	0.6	

Table 3. Electrical Characteristics (TA = 25℃ unless otherwise noted)

DC Characteristics (main path, measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	Breakdown Voltage VGS=-8V; IDS=34mA			200		V
Gate Threshold Voltage	VDS =10V, ID = 34mA	$V_{GS(th)}$	-4		-2	V
Gate Quiescent Voltage	VDS =50V, IDS=280mA, Measured in Functional Test	$V_{GS(Q)}$		-3.2		V

DC Characteristics (peak path, measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	VGS=-8V; IDS=51mA	V _{DSS}		200		V
Gate Threshold Voltage	VDS =10V, ID = 51mA	$V_{GS(th)}$	-4		-2	V
Gate Quiescent Voltage	VDS =50V, IDS=420mA Measured in Functional Test	$V_{GS(Q)}$		-3.2		V

Ruggedness Characteristics

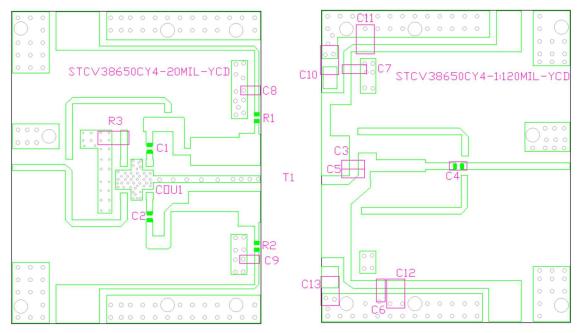
Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Load mismatch capability	3.8GHz, Pout=80W WCDMA 1					
	Carrier in Doherty circuit	VCMD		10.1		
	All phase,	VSWR		10:1		
	No device damages					



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Figure 3: Picture of application board Doherty circuit for 3.8-4.2GHz



Part	Quantity	Description	Part Number	Manufacture
C1,C2,C4,C6,	7	8.2pFHigh Q	251SHS8R2BSE	TEMEX
C7,C8,C9		Capacitor		
C3,C5	2	1.1pFHigh Q	ATC600S1R1	ATC
		Capacitor		
C10,C11,C12,C13	4	10uF MLCC	RS80R2A106M	MARUWA
R1,R2	2	10 Ω Power Resistor	ESR03EZPF100	ROHM
R3	1	51 Ω Power Resistor	RFR50-20CT0421B	YT
COUT1	1	3 dB Bridge	XC3500P-03S	ANAREN
T1	1	650W GaN	STCV38650CY4V	Innogration

Figure 4: Intermodulation Distortion Products versus Two--Tone Spacing

Vdd=50V, Pout=48.5dBm, Center Frequency=3.6GHz

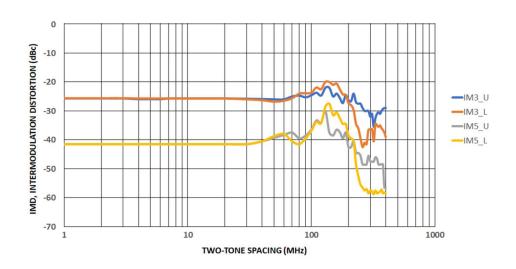




Figure 5: Efficiency and power gain as function of Pout

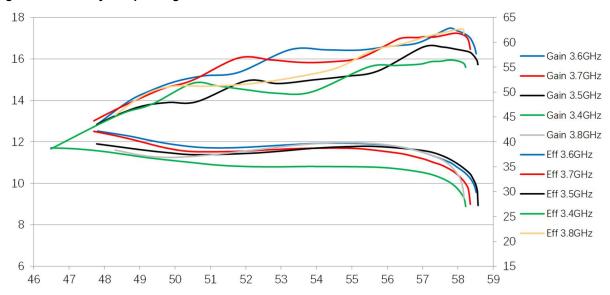
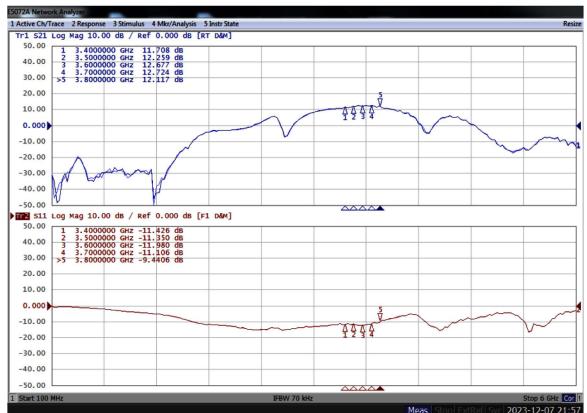
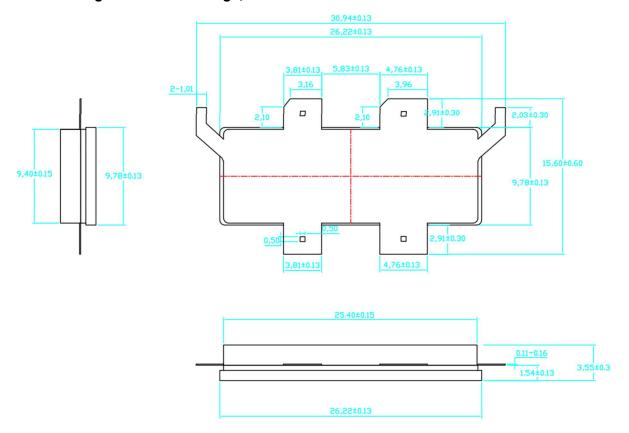


Figure 6: Network analyzer output, S11 and S21



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Earless Flanged Ceramic Package; 6 leads- CY4V



Revision history

Table 4. Document revision history

Date	Revision	Datasheet Status
2023/12/9 V1.0		Preliminary Datasheet Creation

Application data based on LWH-23-25

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